

N-Ch and P-Channel MOSFET

#### **General Description**

The WSF3013 is the highest performance trench N-ch and P-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF3013 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

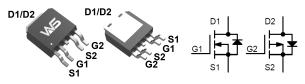
#### **Product Summery**

BVDSS	RDSON	ID
30V	14mΩ	12A
-30V	23mΩ	-11.5A

#### Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- CCFL Back-light Inverter

#### TO-252-4L Pin Configuration



		Rati		
Symbol	Parameter	N-Ch	P-Ch	Units
V <sub>DS</sub>	Drain-Source Voltage	30	-30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	±20	V
	Continuous Drain Current, V <sub>GS(NP)</sub> =10V,T <sub>a</sub> =25 <sup>°</sup> C	12	-11.5	А
ID	Continuous Drain Current, V <sub>GS(NP)</sub> =10V,T <sub>a</sub> =70 <sup>°</sup> C	7.5	-9.6	А
I <sub>DP</sub> <sup>a</sup>	Pulse Drain Current Tested, V <sub>GS(NP)</sub> =10V	48	-48	A
E <sub>AS</sub> <sup>c</sup>	Avalanche Energy, Single pulse , L=0.5mH	20	20	mJ
I <sub>AS</sub> <sup>c</sup>	Avalanche Current, Single pulse , L=0.5mH	9	-9	А
P <sub>D</sub>	Total Power Dissipation, T <sub>a</sub> =25 °C	5.25	5.25	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 175	-55 to 175	°C
TJ	Operating Junction Temperature Range	175	175	°C
R <sub>eJA</sub> <sup>b</sup>	Thermal Resistance-Junction to Ambient, Steady State	60	60	°C/W
R <sub>θJC</sub>	Thermal Resistance-Junction to Case, Steady State	6.25	6.25	°C/W

Note \* : Max. current is limited by bonding wire.

Note a : Pulse width limited by max. junction temperature.

Note  $b : R_{\theta JA}$  steady state t=999s.  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup>, FR-4 board with 2oz. Copper.

Note c : UIS tested and pulse width limited by maximum junction temperature  $175^{\circ}$ C (initial temperature  $T_j=25^{\circ}$ C).

#### **Absolute Maximum Ratings**



## N-Electrical Characteristics (T<sub>J</sub>=25<sup>-1</sup>C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
b a	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =8A		14	18.5	mΩ
R <sub>DS(ON)</sub> <sup>d</sup>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =5A		17	25	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}$ = $V_{DS}$ , $I_D$ =250 $uA$	1.3	1.8	2.3	V
I	Drain-Source Leakage Current	$V_{DS}$ =20V , $V_{GS}$ =0V , $T_J$ =25 $^\circ \! \mathbb{C}$			1	- uA
I <sub>DSS</sub>		$V_{DS}$ =20V , $V_{GS}$ =0V , T <sub>J</sub> =85 $^{\circ}$ C			30	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm20V$ , $V_{DS}$ =0V			±100	nA
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7	3.4	Ω
Qg <sup>e</sup>	Total Gate Charge	V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>DS</sub> =8A		5.2		
Qgs <sup>e</sup>	Gate-Source Charge			1.0		nC
Q <sub>gd</sub> e	Gate-Drain Charge			2.8		
T <sub>d(on)</sub> e	Turn-On Delay Time	$ V_{DD}=15V, R_{L}=15R, \\ I_{DS}=1A, V_{GEN}=10V, \\ R_{G}=6R. $		6		
Tr <sup>e</sup>	Rise Time			8.6		20
T <sub>d(off)</sub> e	Turn-Off Delay Time			16		ns
T <sub>f</sub> e	Fall Time			3.6		
C <sub>iss</sub> e	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		545		
C <sub>oss</sub> <sup>e</sup>	Output Capacitance			95		pF
Crss <sup>e</sup>	Reverse Transfer Capacitance			55		

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	$V_G=V_D=0V$ , Force Current			12	А
V <sub>SD</sub> <sup>d</sup>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.2	V

Note d : Pulse test ; pulse width  ${\leq}300\mu\text{s},$  duty cycle  ${\leq}2\%.$ 

Note e : Guaranteed by design, not subject to production testing.



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-30			V
D d		V <sub>GS</sub> =-10V , I <sub>D</sub> =-12A		23	32.5	
R <sub>DS(ON)</sub> <sup>d</sup>	Static Drain-Source On-Resistance	V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-5A		32	42	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}$ = $V_{DS}$ , $I_D$ =-250 $uA$	-1.3	-1.8	-2.3	V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{\text{DS}}\text{=-20V}$ , $V_{\text{GS}}\text{=}0\text{V}$ , $T_{\text{J}}\text{=}25^\circ\!\!\mathrm{C}$			-1	- uA
IDSS	Drain-Source Leakage Current	$V_{DS}$ =-20V , $V_{GS}$ =0V , $T_{J}$ =85 $^{\circ}$ C			-30	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm20V$ , $V_{DS}$ =0V			±100	nA
Qg <sup>e</sup>	Total Gate Charge			13		
Q <sub>gs</sub> e	Gate-Source Charge	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-12A		1.0		nC
Q <sub>gd</sub> e	Gate-Drain Charge			4.0		
T <sub>d(on)</sub> e	Turn-On Delay Time			8.7		
Tr <sup>e</sup>	Rise Time	$V_{DD}$ =-15V , $V_{GS}$ =-10V , $R_{G}$ =6 $\Omega$ ,		10		20
T <sub>d(off)</sub> e	Turn-Off Delay Time	I <sub>D</sub> =-1A ,R <sub>L</sub> =15Ω,		22		ns
T <sub>f</sub> e	Fall Time			9.0		
C <sub>iss</sub> e	Input Capacitance			580		
C <sub>oss</sub> e	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		105		pF
C <sub>rss</sub> <sup>e</sup>	Reverse Transfer Capacitance			72		

## P-Channel Electrical Characteristics (T<sub>J</sub>=25 <sup>+</sup>C, unless otherwise noted)

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	$V_G = V_D = 0V$ , Force Current			-10	А
V <sub>SD</sub> <sup>e</sup>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25℃			-1.2	V

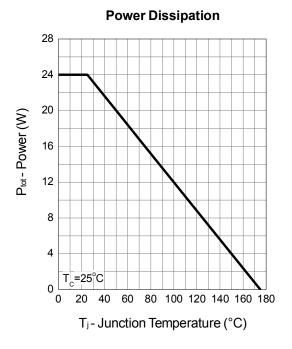
Note d : Pulse test; pulse width $\leq$ 300 $\mu$ s, duty cycle $\leq$ 2%.

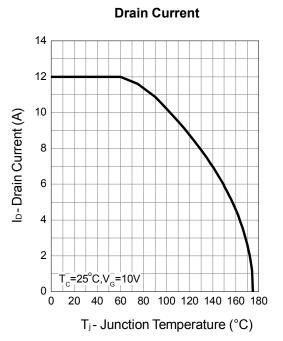
Note e : Guaranteed by design, not subject to production testing.



**N-Ch and P-Channel MOSFET** 

## **N-Channel Typical Characteristics**





DC

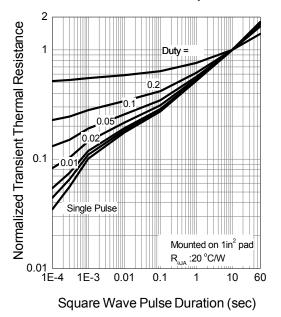
100

10

V<sub>DS</sub> - Drain - Source Voltage (V)

Safe Operation Area

**Thermal Transient Impedance** 



0.1 └─ 0.1

=25°C

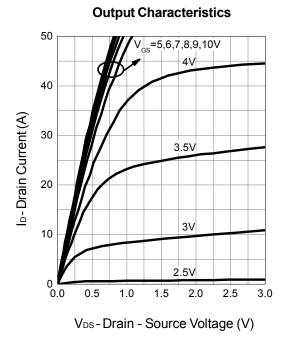
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Ip-Drain Current (A)



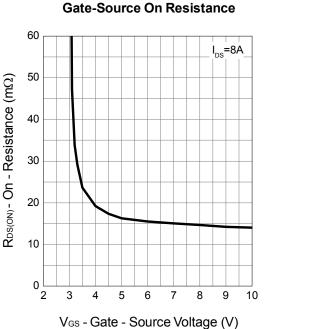
**N-Ch and P-Channel MOSFET** 

## **N-Channel Typical Characteristics**

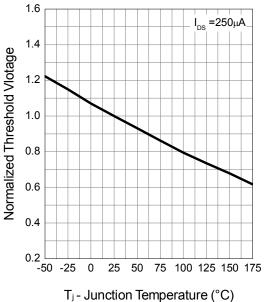


(Cu) = 0 (Cu) = 0

#### Drain-Source On Resistance



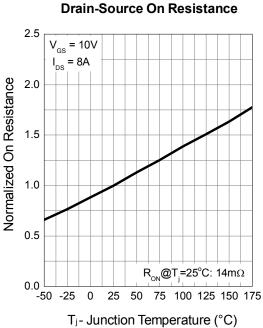
Gate Threshold Voltage



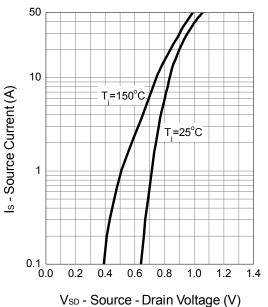


**N-Ch and P-Channel MOSFET** 

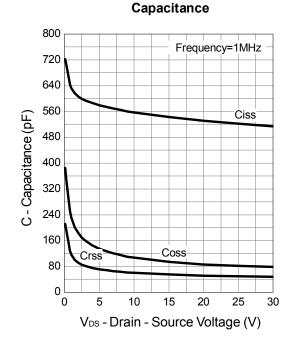
### **N-Channel Typical Characteristics**

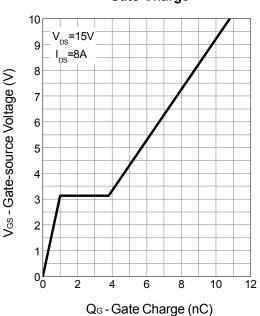


nce Source-Drain Diode Forward



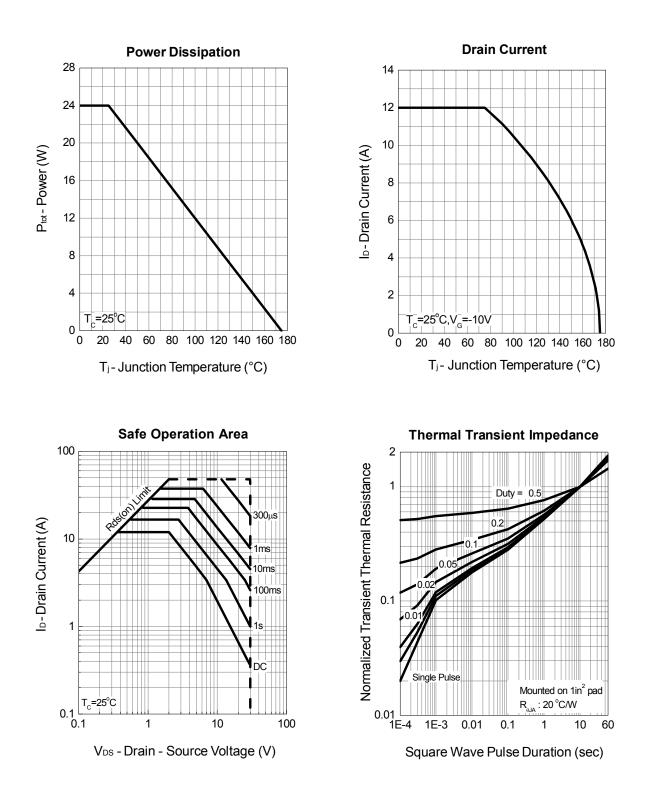
**Gate Charge** 





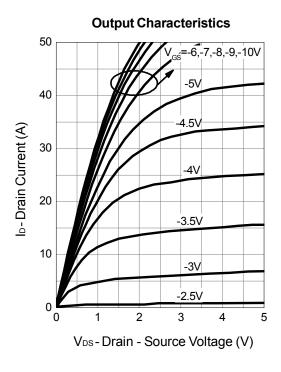


### **P-Channel Typical Characteristics**

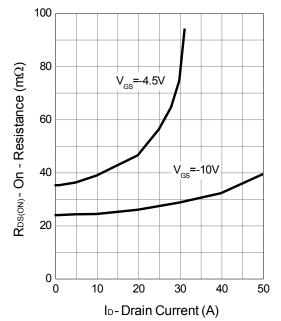


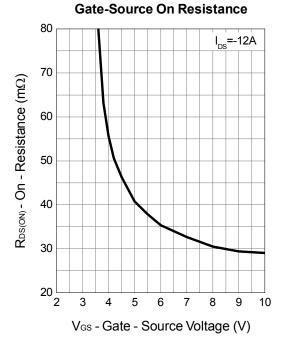


#### **P-Channel Typical Characteristics**

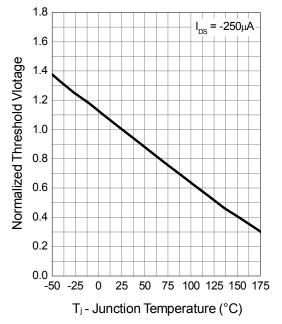


Drain-Source On Resistance



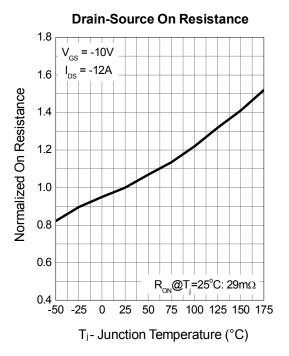


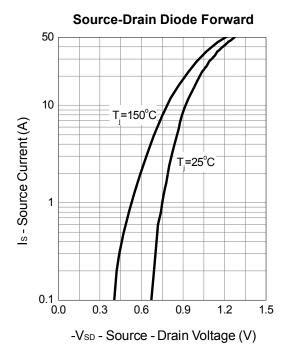
Gate Threshold Voltage

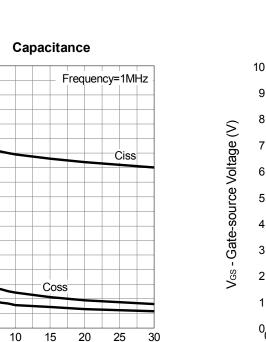




## **P-Channel Typical Characteristics**

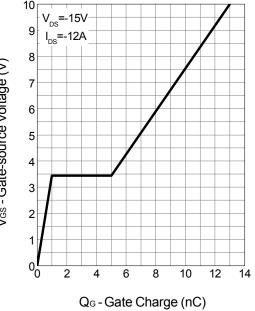






V<sub>DS</sub> - Drain - Source Voltage (V)

Gate Charge



900

800

700

600

500

400

300

200

100 Crss

0 ∟ 0

5

C - Capacitance (pF)



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